

BOARD-TO-BOARD HEADERS & RECEPTACLES





✓ Active



PRODUCT DRAWING



3D PDF

TE CONNECTIVITY (TE)

50 50/50 GRID DRST SFMNT RCPT

AMPMODU | AMPMODU 50/50 Grid

5-104652-5

TE Internal Number: 5-104652-5

Always EU RoHS/ELV Compliant

Connector Style **Receptacle**Centerline **1.27 mm [.05 in]**

Number of Positions 50

Packaging Method Tube, Tube/Box

Contact Mating Area Plating Material Gold

Product Drawings

ASSEMBLY, RECEPTACLE, VERTICAL, DOUBLE ROW, SURFACE

MOUNT, AMPMODU 50/50 GRID CONNECTOR

PDF **English**

CAD Files

3D PDF

PDF **3D**

Customer View Model

2D_DXF.ZIP **English**

Customer View Model

3D_IGS.ZIP **English**

Customer View Model

3D_STP.ZIP **English**

Catalog Pages/Data Sheets

Ribbon Cable Interconnect Solutions

PDF **English**

AMPMODU_INTERCONNECTION_SYSTEM_SECTION1AND2

PDF **English**

Fine Pitch Stacking Connectors - 1.27mm AMPMODU 50/50 Grid Connectors

PDF **English**

Product Specifications

Product Specification AMPMODU* 50/50 Grid Connector System

PDF **English**

Application Specification AMPMODU 50/50 Grid Connectors For SMT PC Board And IDC Ribbon Cable

Applications
PDF
English

Machanical Attachment

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PDF English

Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features	Connector Style	Receptacle
	PCB Mounting Orientation	Vertical
	Row-to-Row Spacing	1.27 mm [.05 in]
	Applies To	Printed Circuit Board
	Product Type	Connector
	Boss	Without
	Series	AMPMODU
	Connector Type	Connector Assembly
Configuration Features	Number of Positions	50
	Number of Rows	2
Electrical Characteristics	Voltage (VAC)	30
	Insulation Resistance (M Ω)	5000
Body Features	Hold-Down Post Plating Material	Tin over Nickel
	Hold-Down Post Plating Thickness	Tin: 150- Nickel: 50
	Hold-Down Post Material	Copper Alloy
Contact Features	Contact Mating Area Plating Material	Gold
	Contact Mating Area Plating Thickness	.762 μm [30 μin]
	Contact Current Rating (A)	4
	Contact Type	Socket
	Solder Tail Contact Plating Material	Tin over Nickel
	Solder Tail Contact Plating Thickness (μin)	150
	Underplate Material	Nickel
	Contact Base Material	Copper Alloy
Termination Features	Termination Method to PC Board	Surface Mount

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iviechanicai Attachment	Mating Alignment	WILL
	Mating Alignment Type	Polarizing Tab
	PCB Mount Retention	With
	PCB Mount Retention Type	Hold-Down Posts
	Mating Connector Lock	Without
Housing Features	Centerline	1.27 mm [.05 in]
	Housing Material	LCP
	Housing Color	Black
Dimensions	Height	4.75 mm [.187 in]
Usage Conditions	Operating Temperature Range (°C)	-65 – 105
Operation/Application	Pick and Place Cover	Without
	Assembly Process Feature	Board Standoff
	For Use With	Receptacle Assembly
Industry Standards	UL Flammability Rating	UL 94V-0
	Approved Standards	CSA LR7189, UL E28476
Packaging Features	Packaging Method	Tube, Tube/Box
	Packaging Quantity	19
Product Compliance	Statement of Compliance	

VIEW ALL PRODUCT COMPLIANCE

CUSTOMERS ALSO BOUGHT



